

IN THE SPECIFICATION:

Please amend paragraph [005], line 2, according to the following:

**[005]** As a method for fabricating a magnesium alloy using a thixoforming process, according to the Japanese patent No. Hei 8-74015, a ~~fillet~~ billet is fabricated in such a manner that a melt is cooled and hardened at a cooling speed of 1°C/second in a temperature region in which a heating temperature does not exceed 30°C in a liquidus line in connection with a mold co-heating temperature. The alloy is maintained for 60 minutes at a temperature 0.5°C higher than a temperature of a solidus line. According to the Japanese patent No. 2001-316753, in order to enhance strength, a magnesium alloy fabrication method is provided based on a thixoforming process in a state that a solid phase is less than 50%. In addition, according to the Japanese patent No. 2003-183794, a magnesium billet is heated in a temperature ranging from 400°C to 500°C and is extruded at a container temperature from 380°C to 440°C, and at an outlet temperature of an extrusions from 400°C to 480°C. A thin and wider plate material is fabricated with an extrusion ratio from 130 to 670.